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DATA SHEET

PART NO.: LT3535IR4CT-R-Y-E-B

REV:

CUSTOMER'S APPROVAL: __ DCC:

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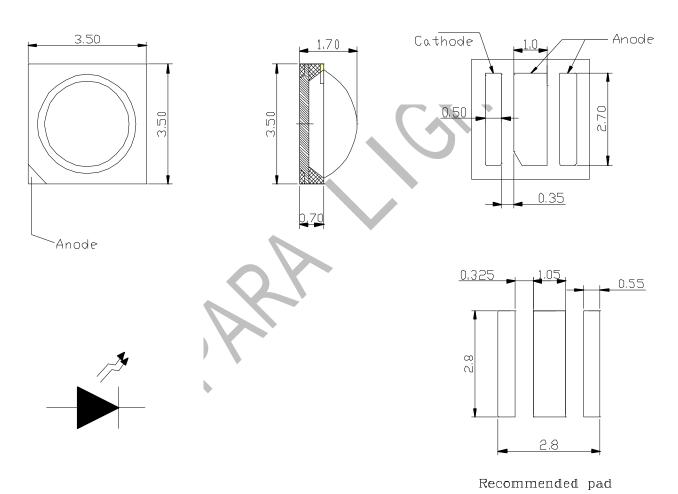
Part No.: LT3535IR4CT-R-Y-E-B

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Features

- * Top view, Wide view angle.
- * EIA STD package,
- * Compatible with automatic Pick & Place equipment.
- * Compatible with IR Reflow soldering and TTW soldering.
- * Pb free product and acceptable lead-free process.
- * Meet RoHS Green Product.

Package Outline Dimensions



Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is \pm 0.15mm (.004") unless otherwise noted.

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• CHIP MATERIALS

* Dice Material : AlGaAs/GaAs

* Lens Color: Water Clear

● Absolute Maximum Ratings(Ta=25°C)

Parameter	Symb I	Rating	Unit
Forward Current	IF	≤1000	mA
Reverse Voltage	VR	5	V
Operating Temperature	Topr	-40~ +85	${\mathbb C}$
Storage Temperature	Tstg	-40 ~ +100	${\mathbb C}$
Junction Temperature	Ţį	125	${\mathbb C}$
IR Reflow Soldering	Tsol	260°C max 5s /2ti	me

• Electro-Optical Characteristics (Ta=25°C)

Produ ct model	Parameter	Symbol	Condition	Min	Тур	Max.	Unit
LT3535IR4CT-R-Y- E-B	Reverse Current	IR	VR=5V			10	μΑ
	Forward Voltage	VF	IF=1000mA	1.8		2.6	V
	Radiant Intensity	le	IF=1000mA		145		mW /sr
	Total Radiant Flux	Фе	IF=1000mA	480	630	1050	mW
	Peak wavelength	λр	IF=1000mA	840	850	870	nm
	Half Intensity Angle	201/2	IF=1000mA		150		deg

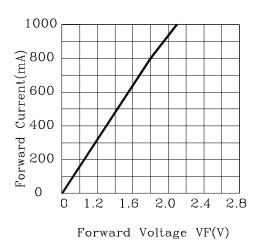
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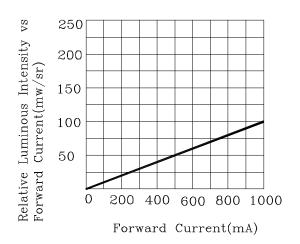


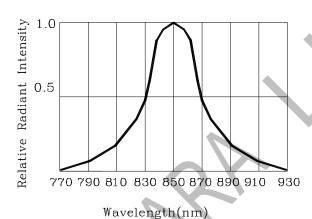
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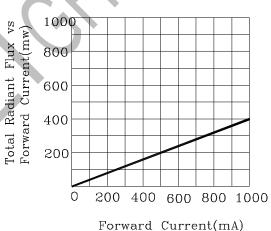
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Typical Electro-Optical Characteristics Curves

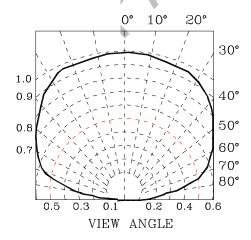








Spectral Distribution



(25°C Ambient Temperature Unless Otherwise Noted)

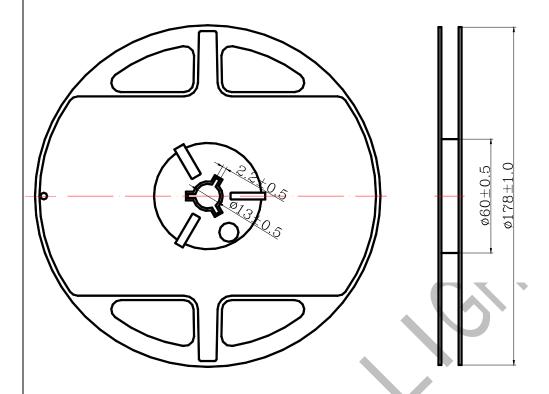
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1. Reel Dimensions



Notes:

- 2. Taping Quantity:1000pcs max
- 3. The tolerances unless noted is ± 0.1 mm, Angle $\pm 0.5^{\circ}$, Unit: mm.

4. Package Dimensions Of Tape And Reel

Item	Spec	•	ØD0 P2 P0
W	12.00±0.30		B B
P1	8.0±0.10		
Do	1.5±0.10		
Po	4.00±0.10	*	
P2	2.00±0.10	Polority	
		_	V
			ØD1

Notes: All dimensions are in millimeters.

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Storage

Before opening the package:

The IREDs should be kept at 30° or less and 90%RH or less. The IREDs should be used within a

year. When storing the IREDs, moisture proof packaging with absorbent material (silica gel) is recommended.

After opening the package:

The IREDs should be kept at 30°C or less and 70%RH or less. The IREDs should be soldered within 24 hours (1days) after opening the package. If unused IREDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It's also recommended to return the IREDs to the original moisture proof bag and to reseal the moisture proof bag again. *If the moisture absorbent material (silica gel) has faded away or the IREDs have exceeded the storage time, baking treatment should be performed using the following condition.

Baking treatment: more than 24 hours at 65+/-5°C

Moisture Proof Package

- *When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the IREDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package.
- *The moisture proof package is made of an aluminum moisture proof bag whit a zipper. A package of a moisture absorbent material (silica gel) is inserted into the aluminum moisture proof bag. The silica gel changes its color from blue to pink as it absorbs moisture.

Heat treatment

- *Thermal design of the end product is of paramount importance. Please consider the heat generation of the IRED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of IRED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- *The operating current should be decided after considering the ambient maximum temperature of IREDs.

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Clean

If cleaning is required, use a clean, soft cloth to lightly wipe off foreign objects with alcohol, and do not use detergents such as acetone to avoid possible corrosion damage.

Electrical precautions

- 1. The LED does not allow reverse drive.
- 2. The current limiting measure is necessary, otherwise a slight voltage change will result in a large current change that may cause the LED to fail.
- 3. Under the premise that the luminous amount meets the requirements, it is recommended to use a drive current below the rated current, which is conducive to improving the reliability of the product.

Anti-static measures

LED is an electrostatic sensitive device, in the process of preservation, use to take anti-static measures. Static electricity and surges can cause changes in product characteristics, such as lower forward voltages, which can be severe and even damage the product. Therefore, for the entire process (production, testing, packaging, etc.) and LED direct contact with the staff should do a good job to prevent and eliminate static electrical measures. All relevant equipment and machines should be properly grounded. Ground AC resistance is less than 1.0 ohms, and the workbench requires a table mat with a surface resistor of 106-109 ohms. Ion fans must also be installed in environments and devices that are prone to static electricity. During the operation, the operator should use anti-static bracelets, anti-static mats, anti-static work clothes, work shoes, gloves, static capacitors and so on.

Electric soldering iron

It is recommended to use an anti-static electric iron at a tip temperature of no more than $350~^{\circ}$ C and less than 3 seconds at each solder. The power of the electric soldering iron should be less than 60W. Two electrode pins are welded separately, after more than 2 seconds after each solder. Do not exert pressure on the lens when soldering. LED problems usually start from solder. Therefore, it is necessary to work carefully as required.

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■Surface Mounting Condition

In automatic mounting of the SMD IREDs on printed circuit boards, any bending, expanding

and pulling forces or shock against the SMD IREDs shall be kept min. to prevent them from

electrical failures and mechanical damages of the devices.

Soldering Reflow

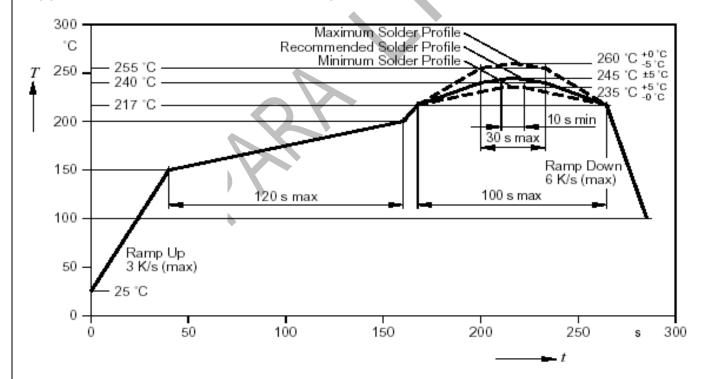
Soldering of the SMD IREDs shall conform to the soldering condition in the individual specifications.

SMD IREDs are designed for Reflow Soldering.

In the reflow soldering, too high temperature and too large temperature gradient such as rapid

heating / cooling may cause electrical & optical failure and damages of the devices . Solidlite can not guarantee the IRED after they have been assembled using the solder dipping method.

Suggest Pb-Free IR Reflow Soldering Profile Condition:



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Bin Code list

Forward Voltage (VF), Unit:v@1000mA				
Bin Code	Min	Max		
B1	1.8	2.0		
B2	2.0	2.2		
C1	2.2	2.4		
C2	2.4	2.6		

Tolerance of each bin are±0.1Volt

Total Radiant Flux , Unit:mW@1000mA			
Bin Code	Min	Max	
15	480	600	
16	600	750	
17	750	920	
18	920	1050	

Tolerance of each bin are±15%

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